Table 1. SMP1322 Series Packaging and Marking

			
Single	Series Pair	Single	Single
SOT-23	SOT-23	SC-79 Green™	SOD-882 Green™
SMP1322-001LF Green™ Marking: RN1	**SMP1322-005LF** Green™ Marking: RN2	**SMP1322-079LF** Marking: Cathode and CC	**SMP1322-040LF** Marking: T
L_S = 1.5 nH	L_S = 1.5 nH	L_S = 0.7 nH	L_S = 0.45 nH
	SC-70		
	SMP1322-075LF Green™ Marking: RN2		
	L_S = 1.4 nH		

The Pb-free symbol or "LF" in the part number denotes a lead-free, RoHS-compliant package unless otherwise noted as Green™. Tin/lead (Sn/Pb) packaging is not recommended for new designs.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SMP1322 series are provided in Table 2. Electrical specifications are provided in Table 3. Resistance versus temperature measurements are provided in Table 4.

Typical performance characteristics of the SMP1322 series are illustrated in Figures 1 to 4. Package dimensions are shown in Figures 5 to 11 (odd numbers), and tape and reel dimensions are provided in Figures 6 to 12 (even numbers).

Table 2. SMP1322 Series Absolute Maximum Ratings[1]

Parameter	Symbol	Minimum	Maximum	Units
Reverse voltage	V_R		50	V
Power dissipation @ 25 °C lead temperature	P_D		430	mW
Storage temperature	T_{STG}	–65	+150	°C
Operating temperature	T_A	–65	+150	°C
Electrostatic discharge:	ESD			
Charged Device Model (CDM), Class 4			1000	V
Human Body Model (HBM), Class 1B			1000	V

1 Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

Table 3. SMP1322 Series Electrical Specifications[1]
(T_A = +25 °C, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Reverse current	I_R	V_R = 50 V			10	µA
Capacitance	C_T	F = 1 MHz, V = 30 V			1	pF
Resistance	R_S	F = 100 MHz I = 1 mA I = 10 mA		 0.5	 1.5	 Ω Ω
Forward voltage	V_F	I_F = 10 mA		0.85		V
Carrier lifetime	TI	I_F = 10 mA		0.4		µs
I region width				7		µm

[1] Performance is guaranteed only under the conditions listed in this table.

ESD HANDLING: *Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.*

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SMP1322 series is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering.

For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

Table 4. Resistance vs Temperature @ 500 MHz

I_F (mA)	R_S @ –55 °C (Ω)	R_S @ –15 °C (Ω)	R_S @ +25 °C (Ω)	R_S @ +65 °C (Ω)	R_S @ +100 °C (Ω)
0.02	9.5	9.4	9.9	10.5	10.9
0.10	3.0	3.0	3.0	3.3	3.5
0.30	1.5	1.5	1.5	1.6	1.8
0.50	1.1	1.1	1.2	1.2	1.4
1.0	0.922	0.914	0.902	0.963	1.100
10	0.568	0.559	0.533	0.563	0.655
20	0.532	0.520	0.494	0.521	0.610
100	0.483	0.469	0.440	0.464	0.565

Typical Performance Characteristics

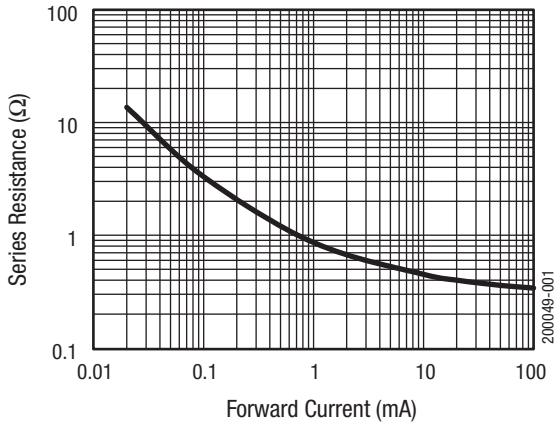


Figure 1. Series Resistance vs Current @ 100 MHz

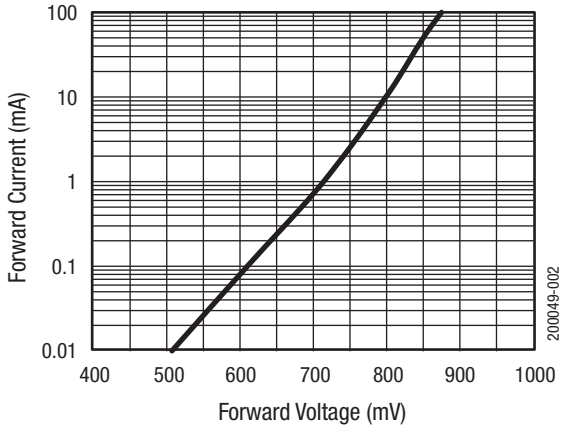


Figure 2. Forward Current vs Voltage

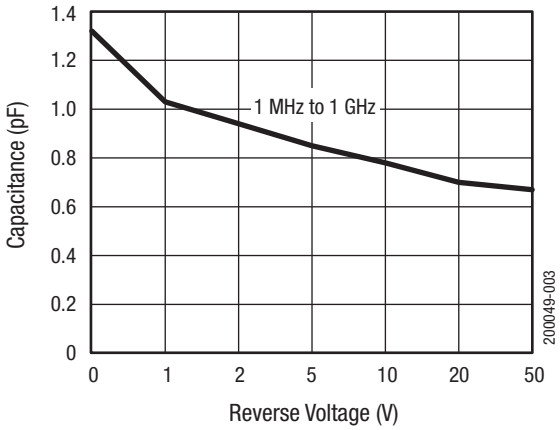


Figure 3. Capacitance vs Reverse Voltage

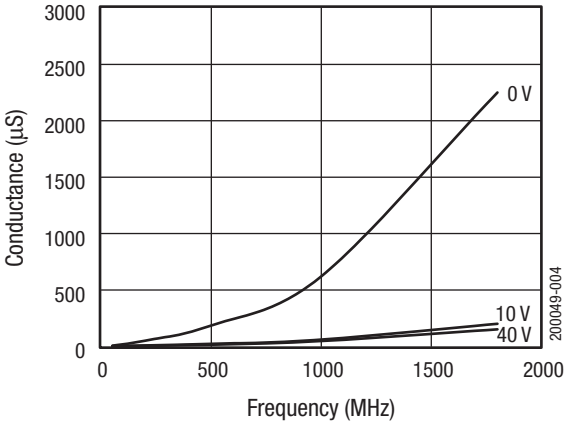
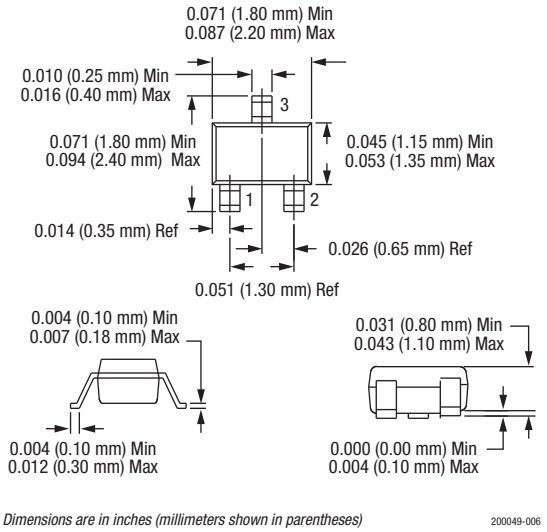
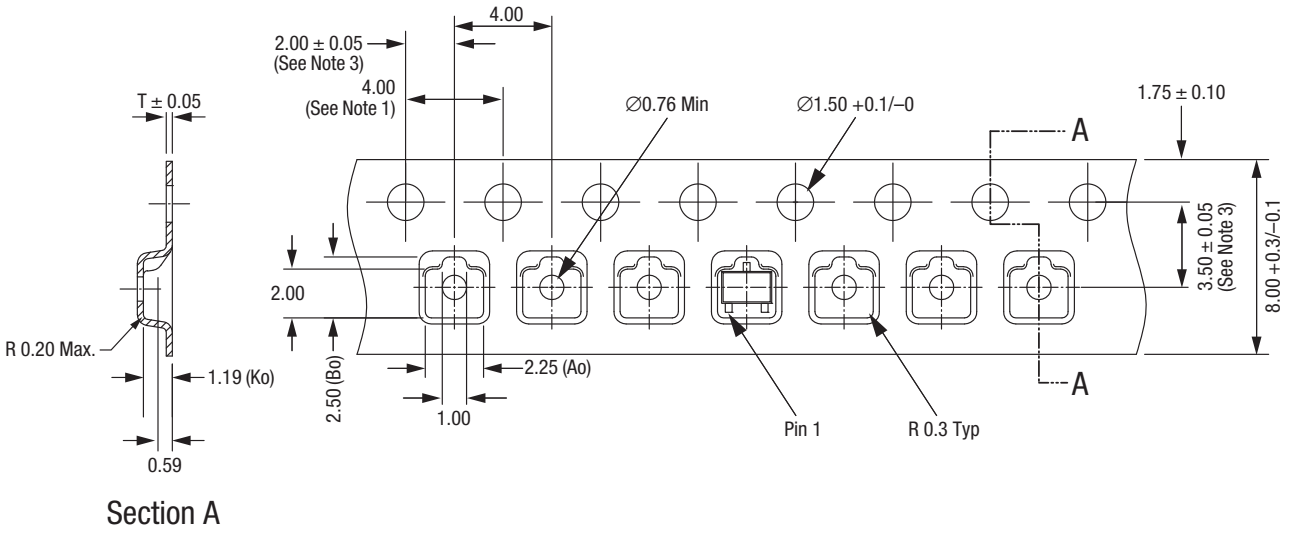


Figure 4. Conductance vs Frequency and Reverse Voltage



Dimensions are in inches (millimeters shown in parentheses) 200049-006

Figure 5. SC-70 Package Dimension Drawing



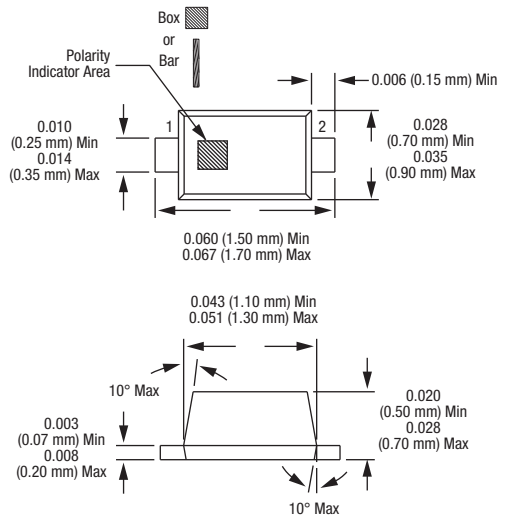
Section A

Notes:

1. *Sprocket hole pitch cumulative tolerance ±0.2 mm.*
2. *Carrier tape: black conductive polystyrene.*
3. *Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.*
4. *Cover tape material: transparent and conductive material.*
5. *All measurements are in millimeters.*

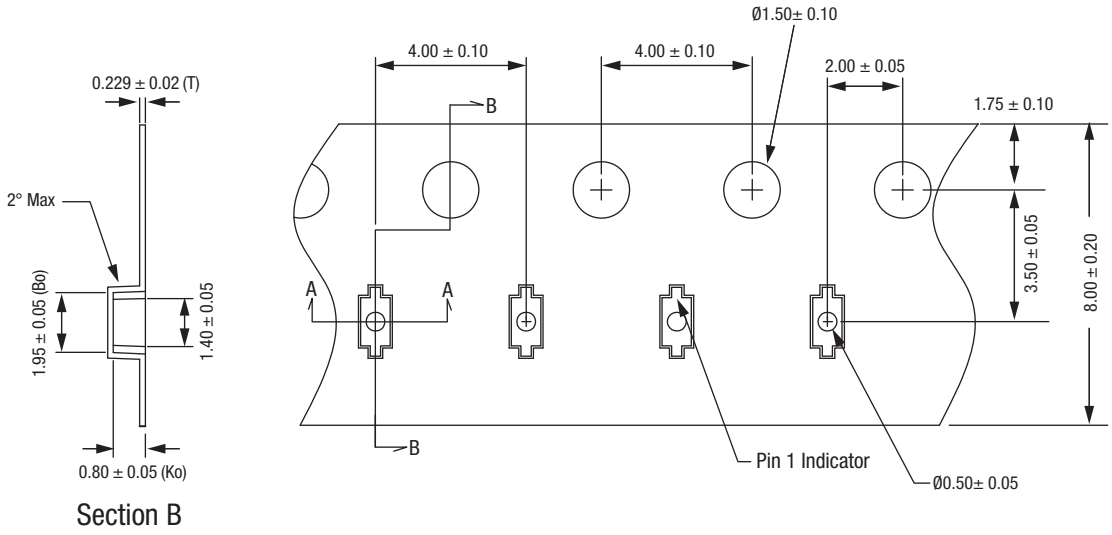
200049-007

Figure 6. SC-70 Tape and Reel Dimensions



Dimensions are in inches (millimeters shown in parentheses) 200049-008

Figure 7. SC-79 Package Dimension Drawing

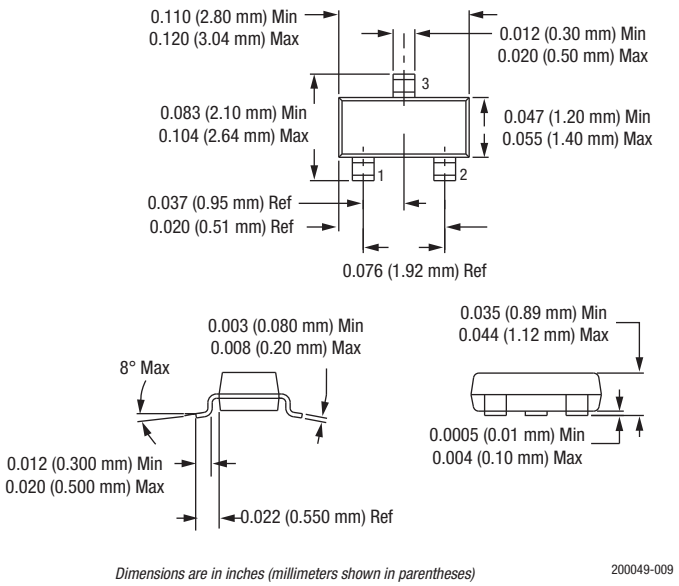


Notes:

1. *Carrier tape: black conductive polycarbonate or polystyrene.*
2. *Cover tape material: transparent conductive PSA.*
3. *Cover tape size: 5.4 mm width.*
4. *ESD-surface resistivity is ≤1 x 10^8 Ohms/square per EIA, JEDEC TNR Specification.*
5. *All measurements are in millimeters.*

200049-009

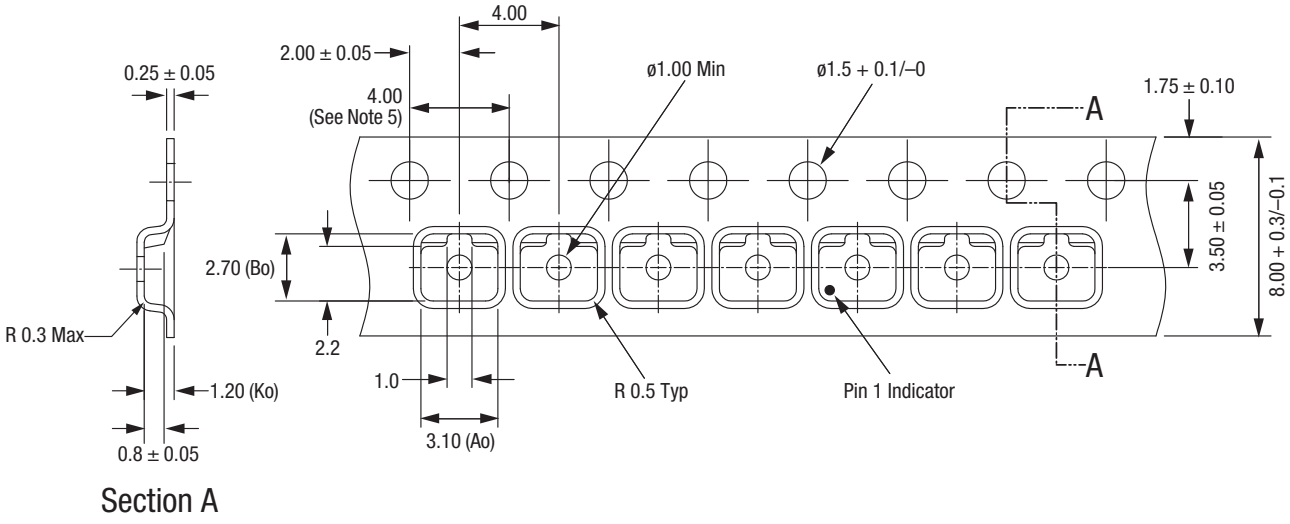
Figure 8. SC-79 Tape and Reel Dimensions



Dimensions are in inches (millimeters shown in parentheses)

200049-009

Figure 9. SOT-23 Package Dimension Drawing

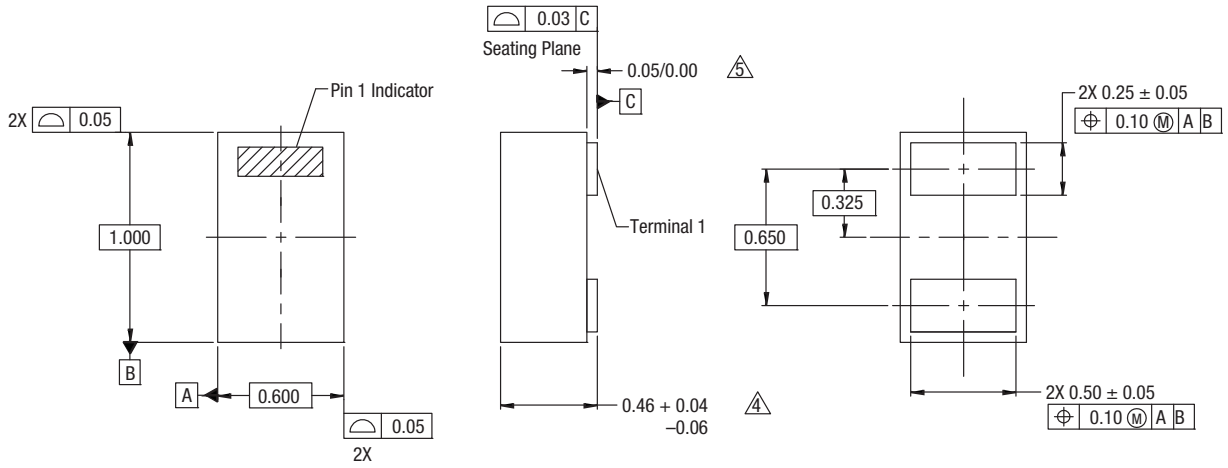


Notes:

1. *Carrier tape: black conductive polycarbonate.*
2. *Cover tape material: transparent conductive PSA.*
3. *Cover tape size: 5.40 mm width.*
4. *Tolerance ±0.10 mm.*
5. *Ten sprocket hole pitch cumulative tolerance: ±0.2 mm.*
6. *All measurements are in millimeters.*
7. *Alternative carrier tape dimensions are:*
   Ao = 3.3
   Bo = 2.9
   Ko = 1.22

200049-011

Figure 10. SOT-23 Tape and Reel Dimensions

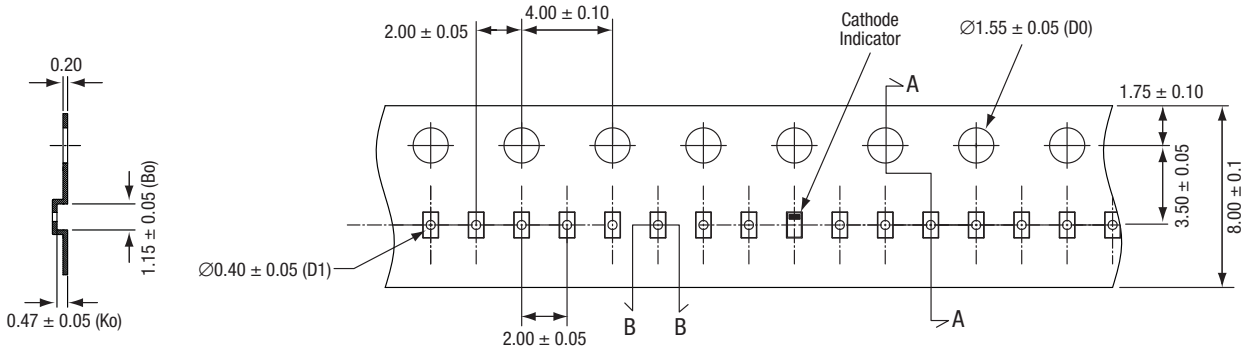


Notes:

1. *All measurements are in millimeters.*
2. *Dimensions and tolerances according to ASME Y14.5M-1994.*
3. *These packages are used principally for discrete devices.*
4. *This dimension includes stand-off height and package body thickness, but does not include attached features, e.g., external heatsink or chip capacitors. An integral heatslug is not considered an attached feature.*
5. *This dimension is primarily terminal plating, but does not include small metal protrusion.*

200049-012

Figure 11. SOD-882 Package Dimension Drawing



Notes:

1. *Carrier tape: black conductive polycarbonate.*
2. *Cover tape: transparent conductive material.*
3. *Cover tape size: 5.4 mm width.*
4. *ESD surface resistivity is ≥1 x 10^4 ~ ≤ 1 x 10^8 Ohms/square.*
5. *All dimensions are in millimeters.*

200049-013

Figure 12. SOD-882 Tape and Reel Dimensions

Mouser Electronics

Authorized Distributor

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Skyworks:

SMP1322-005LF SMP1322-040LF SMP1322-079LF SMP1322-003LF SMP1322-001LF SMP1322-016LF SMP1322-017LF SMP1322-074LF SMP1322-011LF SMP1322-004LF SMP1322-075LF